MAINTENANCE BOND OR LETTER OF CREDIT DEVELOPMENT APPLICATION

City of Westfield

Bond No. _____

To petition the City of Westfield to initiate the process of accepting all of or a portion of a project and to begin the process of obtaining a Maintenance Bond or Letter of Credit for Maintenance the following application must be completed and submitted to:
Westfield Public Works, 2706 E 171st. Street, Westfield, Indiana 46074.

Maintenance Bond ☐ **Letter of Credit** ☐

Name of project			
Description of portion of project proposed to be accepted by the City (Attach 8 1/2" x 11" map showing location)			
Contractor/Developer name	*Name of primary contact*	*Address*	*Telephone number* *Fax number*

CONSTRUCTION ACTUAL COST			
Streets	$	Streets	Bond #
Water	$	Water	Bond #
Sanitary sewer	$	Sanitary sewer	Bond #
Storm sewer	$	Storm sewer	Bond #
Sidewalk	$	Sidewalk	Bond #
TOTAL	$	***Maintenance Bond or Letter of Credit Value (To be 10% of actual construction cost)***	$

Signature of Contractor/Developer	*Date signed*

For City use only

Execution of this Maintenance Bond or Letter of Credit for Maintanence Application by the City of Westfield signifies their acceptance of the above described project.

Date Received _____

Date of Initial Acceptance by Board of Public Works & Safety _____

_____
Board of Public Works & Safety

Date of final acceptance punch list (90 days prior to bond expiration) _____

_____
Director of Public Works

Date of bond release by City _____

_____
Development/Construction Supervisor

COPY: Community Development